AMPMODU | AMPMODU 50/50 Grid

TE Internal #: 1571424-6

PCB Mount Header, Vertical, Board-to-Board, 50 Position, 1.27 mm [.05 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder,

AMPMODU 50/50 Grid

View on TE.com >

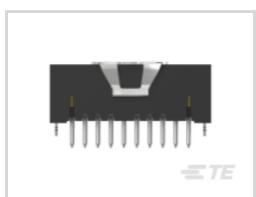


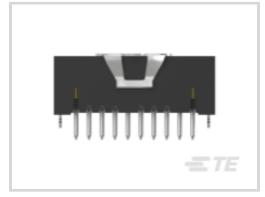
Connectors > PCB Connectors > PCB Headers & Receptacles











PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Dielectric Withstanding Voltage (Max)

Insulation Resistance

Number of Positions: 50

Number of Rows: 2

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Loaded Positions	50
PCB Mount Orientation	Vertical
Number of Positions	50
Number of Rows	2
Electrical Characteristics	
Termination Resistance	12 mΩ

300 VAC

 $5000~\mathrm{M}\Omega$



Body Features

2 out 1 out a 1	
Assembly Process Feature Material	Aluminum
Primary Product Color	Black
Contact Features	
PCB Contact Termination Area Plating Material Thickness	3.81 μm[150 μin]
Contact Layout	Inline
Mating Pin Diameter	.46 mm[.018 in]
PCB Contact Termination Area Plating Material Finish	Matte
Contact Shape & Form	Dual, Round
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Contact Type	Pin
Contact Current Rating (Max)	.5 A
Termination Features	
Round Termination Post & Tail Diameter	.45 mm[.018 in]
Termination Post & Tail Length	2.46 mm[.097 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
PCB Mount Alignment Type	Hold-Down
PCB Mount Retention Type	Hold-Down
Mating Alignment	With
Mating Alignment Type	Polarization
PCB Mount Retention	With
PCB Mount Alignment	With
Connector Mounting Type	Board Mount
Housing Features	
Mating Entry Location	Тор
Centerline (Pitch)	1.27 mm[.05 in]
Housing Material	LCP (Liquid Crystal Polymer)



Dimensions

Connector Length	60.25 mm[2.38 in]
Connector Height	5.73 mm[.23 in]
Connector Width	5.72 mm[.23 in]
Row-to-Row Spacing	1.27 mm[.05 in]
Stack Height	6.35 mm[.25 in]
PCB Thickness (Recommended)	1.57 mm[.062 in]
Usage Conditions	
Housing Temperature Rating	High
Housing Temperature Rating Operating Temperature Range	High -65 - 105 °C[-85 - 221 °F]
Operating Temperature Range	

Industry Standards

Packaging Features	C3A LI(7107, OL L20470
Compatible With Approved Standards Products	CSA LR7189, UL E28476
Compatible With Agency/Standards Products	CSA, UL

Tape & Reel

Product Compliance

Packaging Method

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JAN 2024 (240) SVHC > Threshold: Pb (13% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not reviewed for solder process capability



Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



TE Part # 104893-5 50 50/50 GRID CABLE RECPT



TE Part # 104652-5 50 50/50 GRID DRST SFMNT RCPT



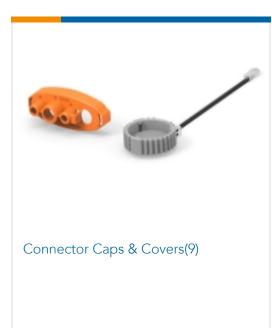
TE Part # 147384-5 50 50/50 GRID DR SMT RCPT VC







Also in the Series | AMPMODU 50/50 Grid





Insertion & Extraction Tools(1)



PCB Headers & Receptacles(299)



Ribbon Cable Connectors(34)

Customers Also Bought

















Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1571424-6_1.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1571424-6_1.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1571424-6_1.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

AMPMODU 50/50 GRID THRU-HOLE

English

Product Specifications

Application Specification

English

Agency Approvals

UL Report

English